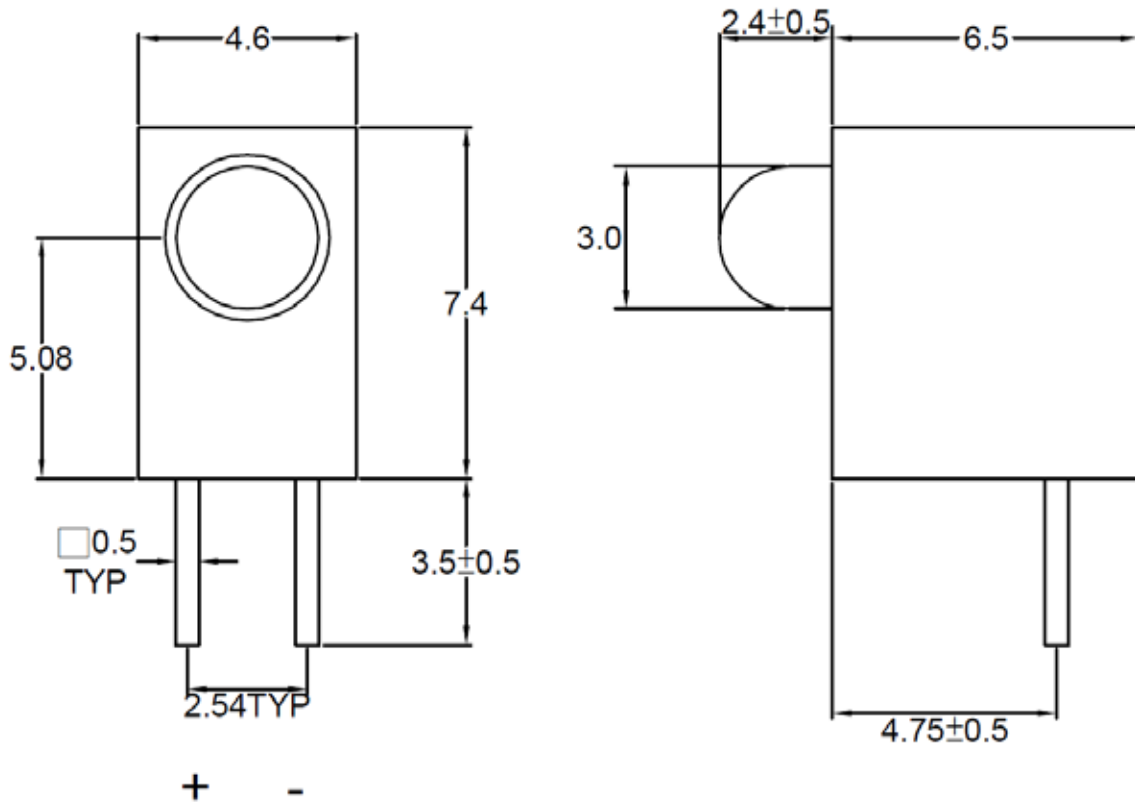


SPECIFICATION **CB29B1D**
PACKAGE OUTLINES

Notes:

1. All dimensions are in millimeters (inches).
2. Tolerance is ± 0.25mm (0.01") unless otherwise noted.
3. Specifications are subject to change without notice.

Part Number	Chip Material	Color of Emission	Lens Type	Viewing Angle
CB29B1D	InGaN	Blue	Blue Diffused	36°



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ABSOLUTE MAXIMUM RATINGS
(TA=25°C)

Parameter	Symbol	Max Rating	Unit
Forward Current	I _F	30	mA
Reverse Current @ 5V	I _R	50	μA
Power Dissipation	P _d	85	mW
Operating Temperature Range	T _{OP}	-20~+80	°C
Storage Temperature Range	T _{STG}	-30~+100	°C
Peak Pulsing Current (1/10 duty f = 10KHz)	I _{FP}	100	mA
Soldering Temperature	T _{SOL}	Max 260°C for 5 sec Max	

OPTICAL-ELECTRICAL CHARACTERISTICS
(TA=25°C)

Parameter	Symbol	Test Condition	Color	Value			Unit
				Min	Typ	Max	
Luminous Intensity	I _v	I _F = 20mA	Blue	35	70	-	mcd
Forward Voltage	V _F	I _F = 20mA	Blue		3.5	4.0	V
Viewing Angle at 50% I _v	2θ _{1/2}	I _F = 20mA	-	-	36	-	Deg
Peak Wavelength	λ _P	I _F = 20mA	Blue	-	470	-	nm
Dominant Wavelength	λ _D	I _F = 20mA	Blue	-	465	-	nm

*Tolerance of viewing angle: -10 / +5 deg.



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OPTICAL CHARACTERISTIC CURVES - BLUE

Fig.1 Forward current vs. Forward Voltage

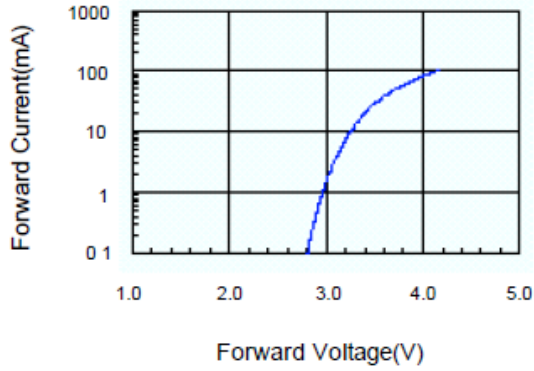


Fig.2 Relative Intensity vs. Forward Current

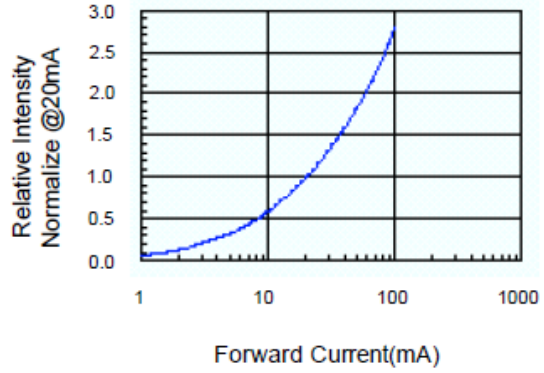


Fig.3 Forward Voltage vs. Temperature

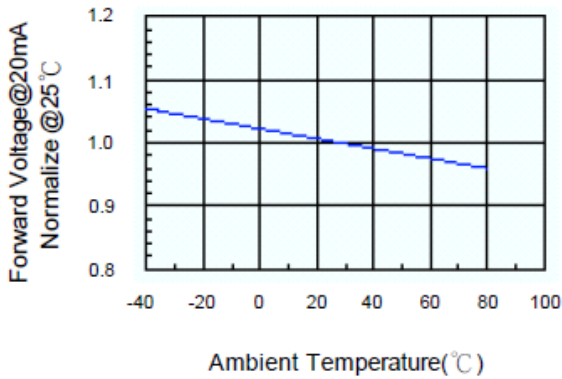


Fig.4 Relative Intensity vs. Temperature

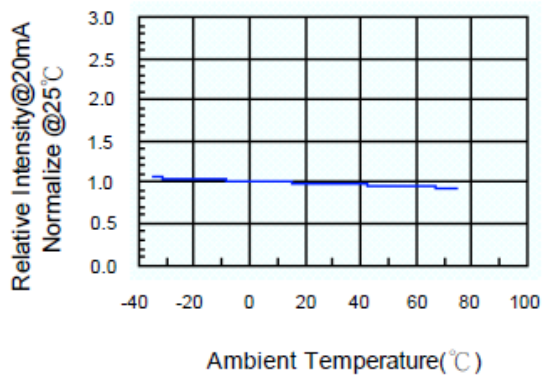
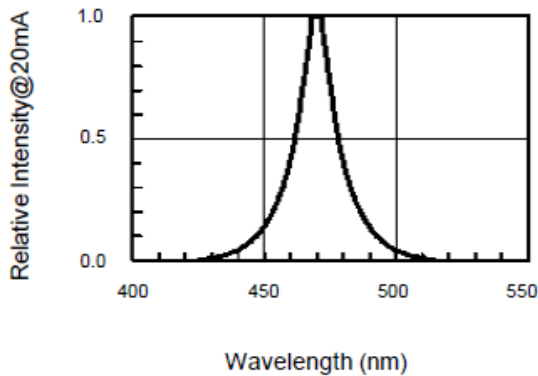


Fig.5 Relative Intensity vs. Wavelength



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RELIABILITY TEST FOR LED LAMPS

RELIABILITY TEST:

Test Item	Test Condition	Description	Reference Standard
Operating Life Test	1.Under Room Temperature 2.If=20mA 3.t=1000 hrs (-24hrs, +72hrs)	This test is conducted for the purpose of determining the resistance of a part in electrical and thermal stressed.	MIL-STD-750: 1026 MIL-STD-883: 1005 JIS C 7021: B-1
High Temperature Storage Test	1.Ta=105 °C ±5°C 2.t=1000 hrs (-24hrs, +72hrs)	The purpose of this is the resistance of the device which is laid under condition of high temperature for hours.	MIL-STD-883:1008 JIS C 7021: B-10
Low Temperature Storage Test	1.Ta=-40 °C ±5°C 2.t=1000 hrs (-24hrs, +72hrs)	The purpose of this is the resistance of the device which is laid under condition of low temperature for hours.	JIS C 7021: B-12
High Temperature High Humidity Test	1.Ta=65 °C ±5°C 2.RH=90 %~95 % 3.t=240hrs ±2hrs	The purpose of this test is the resistance of the device under tropical for hours.	MIL-STD-202:103B JIS C 7021: B-11
Thermal Shock Test	1.Ta=105 °C ±5°C & -40 °C ±5°C (10min) (10min) 2.total 10 cycles	The purpose of this is the resistance of the device to sudden extreme changes in high and low temperature.	MIL-STD-202: 107D MIL-STD-750: 1051 MIL-STD-883: 1011
Solder Resistance Test	1.T.Sol=260 °C ±5°C 2.Dwell time= 10 ±1sec.	This test intended to determine the thermal characteristic resistance of the device to sudden exposures at extreme changes in temperature when soldering the lead wire.	MIL-STD-202: 210A MIL-STD-750: 2031 JIS C 7021: A-1
Solderability Test	1.T.Sol=230 °C ±5°C 2.Dwell time=5 ±1sec	This test intended to see soldering well performed or not.	MIL-STD-202: 208D MIL-STD-750: 2026 MIL-STD-883: 2003 JIS C 7021: A-2



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